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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

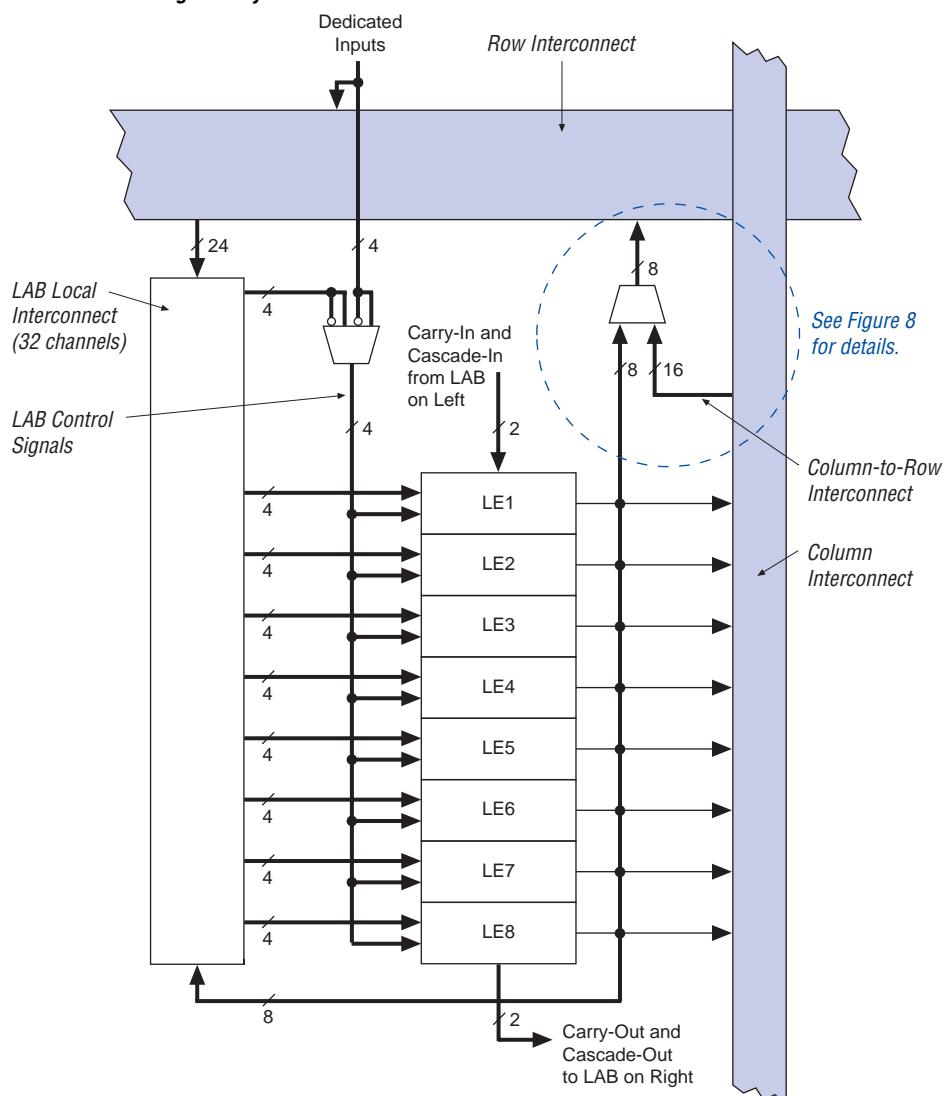
Details

Product Status	Obsolete
Number of LABs/CLBs	84
Number of Logic Elements/Cells	672
Total RAM Bits	-
Number of I/O	152
Number of Gates	8000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8820aqc208-3

Logic Array Block

A logic array block (LAB) consists of eight LEs, their associated carry and cascade chains, LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure of the FLEX 8000 architecture. This structure enables FLEX 8000 devices to provide efficient routing, high device utilization, and high performance. [Figure 2](#) shows a block diagram of the FLEX 8000 LAB.

Figure 2. FLEX 8000 Logic Array Block

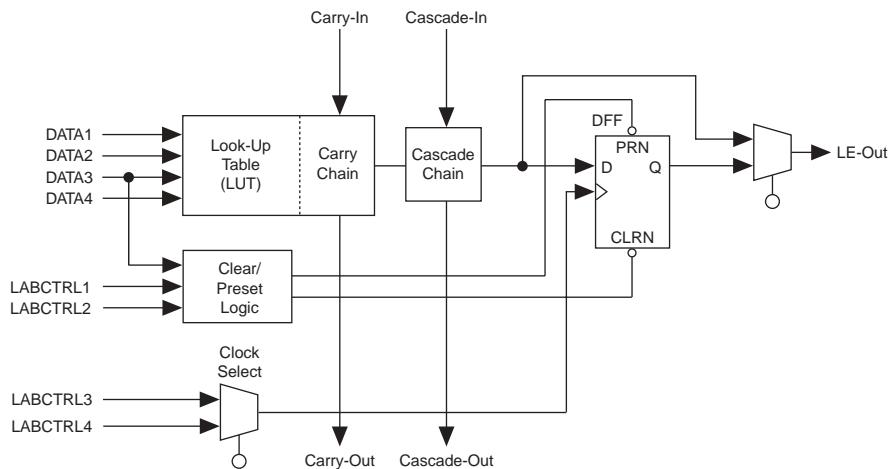


Each LAB provides four control signals that can be used in all eight LEs. Two of these signals can be used as clocks, and the other two for clear/preset control. The LAB control signals can be driven directly from a dedicated input pin, an I/O pin, or any internal signal via the LAB local interconnect. The dedicated inputs are typically used for global clock, clear, or preset signals because they provide synchronous control with very low skew across the device. FLEX 8000 devices support up to four individual global clock, clear, or preset control signals. If logic is required on a control signal, it can be generated in one or more LEs in any LAB and driven into the local interconnect of the target LAB.

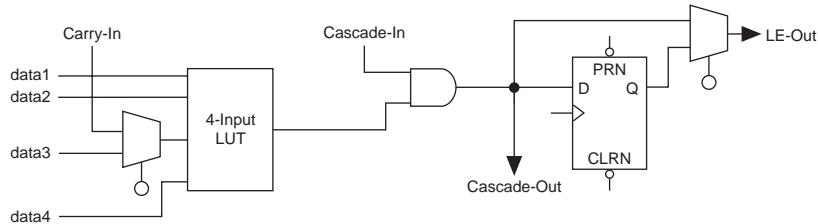
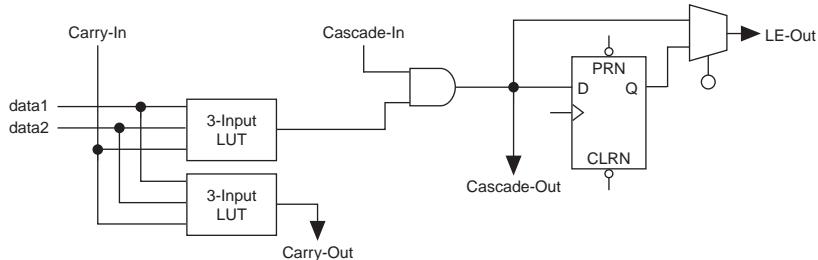
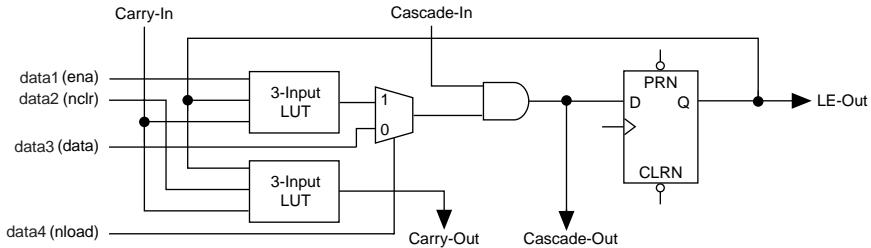
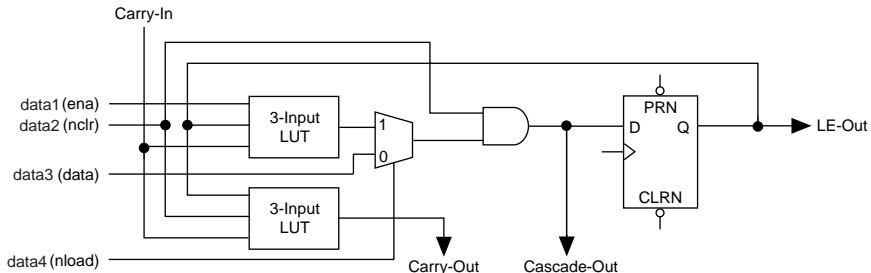
Logic Element

The logic element (LE) is the smallest unit of logic in the FLEX 8000 architecture, with a compact size that provides efficient logic utilization. Each LE contains a 4-input LUT, a programmable flipflop, a carry chain, and cascade chain. [Figure 3](#) shows a block diagram of an LE.

Figure 3. FLEX 8000 LE



The LUT is a function generator that can quickly compute any function of four variables. The programmable flipflop in the LE can be configured for D, T, JK, or SR operation. The clock, clear, and preset control signals on the flipflop can be driven by dedicated input pins, general-purpose I/O pins, or any internal logic. For purely combinatorial functions, the flipflop is bypassed and the output of the LUT goes directly to the output of the LE.

Figure 6. FLEX 8000 LE Operating Modes**Normal Mode****Arithmetic Mode****Up/Down Counter Mode****Clearable Counter Mode**

Internal Tri-State Emulation

Internal tri-state emulation provides internal tri-stating without the limitations of a physical tri-state bus. In a physical tri-state bus, the tri-state buffers' output enable signals select the signal that drives the bus. However, if multiple output enable signals are active, contending signals can be driven onto the bus. Conversely, if no output enable signals are active, the bus will float. Internal tri-state emulation resolves contending tri-state buffers to a low value and floating buses to a high value, thereby eliminating these problems. The MAX+PLUS II software automatically implements tri-state bus functionality with a multiplexer.

Clear & Preset Logic Control

Logic for the programmable register's clear and preset functions is controlled by the DATA3, LABCTRL1, and LABCTRL2 inputs to the LE. The clear and preset control structure of the LE is used to asynchronously load signals into a register. The register can be set up so that LABCTRL1 implements an asynchronous load. The data to be loaded is driven to DATA3; when LABCTRL1 is asserted, DATA3 is loaded into the register.

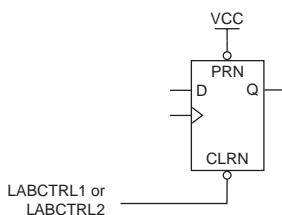
During compilation, the MAX+PLUS II Compiler automatically selects the best control signal implementation. Because the clear and preset functions are active-low, the Compiler automatically assigns a logic high to an unused clear or preset.

The clear and preset logic is implemented in one of the following six asynchronous modes, which are chosen during design entry. LPM functions that use registers will automatically use the correct asynchronous mode. See [Figure 7](#).

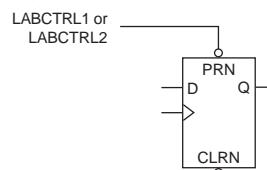
- Clear only
- Preset only
- Clear and preset
- Load with clear
- Load with preset
- Load without clear or preset

Figure 7. FLEX 8000 LE Asynchronous Clear & Preset Modes

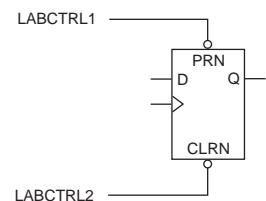
Asynchronous Clear



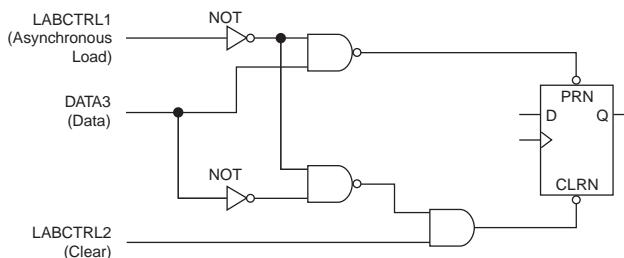
Asynchronous Preset



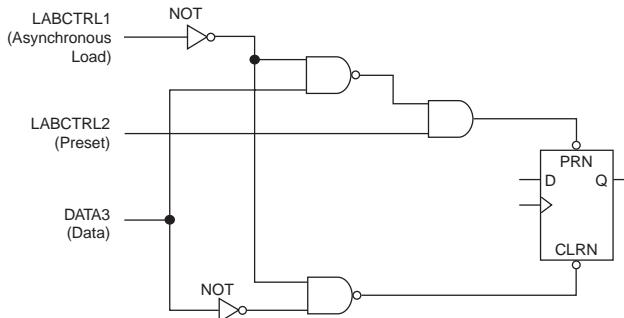
Asynchronous Clear & Preset



Asynchronous Load with Clear



Asynchronous Load with Preset



Asynchronous Load without Clear or Preset

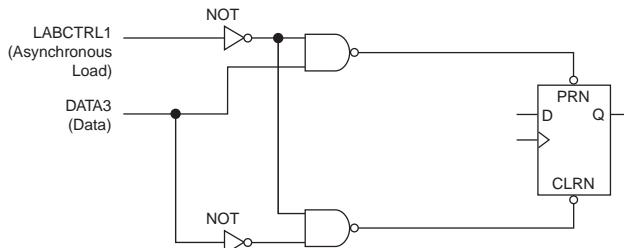
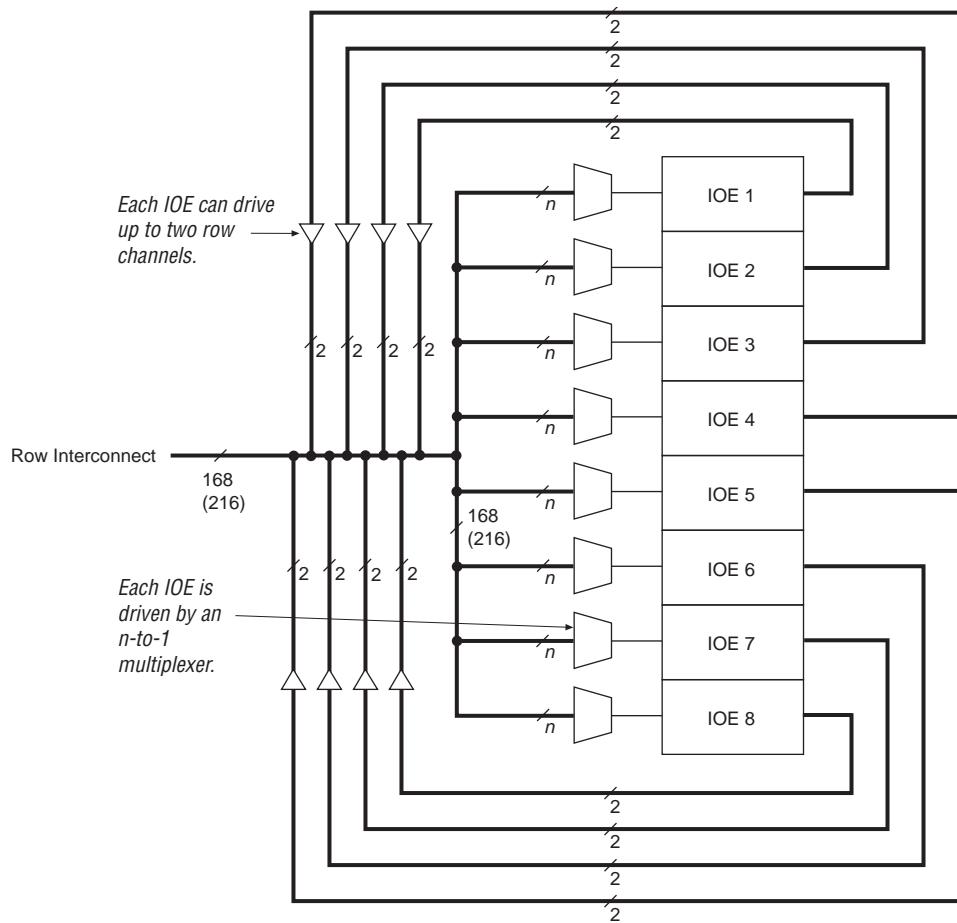


Figure 11. FLEX 8000 Row-to-IOE Connections

Numbers in parentheses are for EPF81500A devices. See Note (1).



Note:

- (1) $n = 13$ for EPF8282A and EPF8282AV devices.
- $n = 21$ for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
- $n = 27$ for EPF81500A devices.

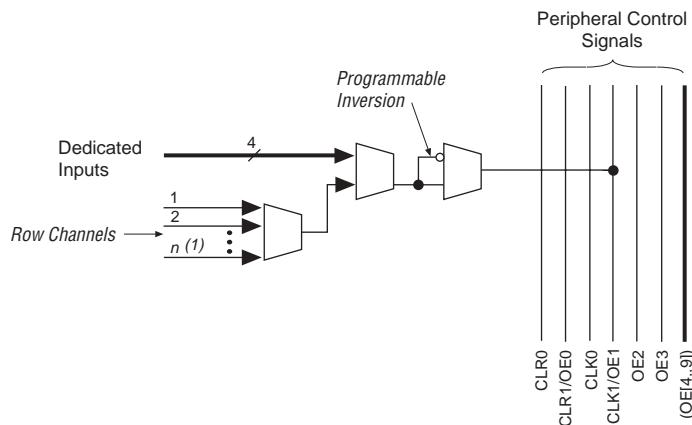
Column-to-IOE Connections

Two IOEs are located at the top and bottom of the column channels (see Figure 12). When an IOE is used as an input, it can drive up to two separate column channels. The output signal to an IOE can choose from 8 of the 16 column channels through an 8-to-1 multiplexer.

The signals for the peripheral bus can be generated by any of the four dedicated inputs or signals on the row interconnect channels, as shown in [Figure 13](#). The number of row channels in a row that can drive the peripheral bus correlates to the number of columns in the FLEX 8000 device. EPF8282A and EPF8282AV devices use 13 channels; EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices use 21 channels; and EPF81500A devices use 27 channels. The first LE in each LAB is the source of the row channel signal. The six peripheral control signals (12 in EPF81500A devices) can be accessed by each IOE.

Figure 13. FLEX 8000 Peripheral Bus

Numbers in parentheses are for EPF81500A devices.



Note:

- (1) $n = 13$ for EPF8282A and EPF8282AV devices.
- $n = 21$ for EPF8452A, EPF8636A, EPF8820A, and EPF81188A devices.
- $n = 27$ for EPF81500A devices.

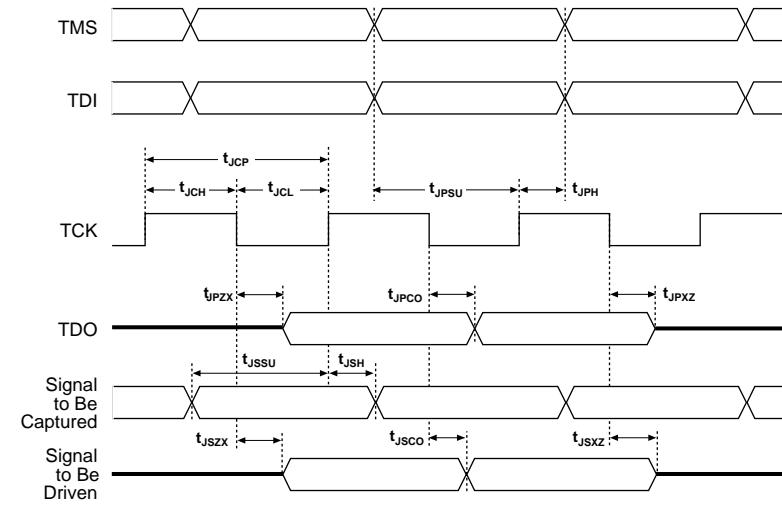
The instruction register length for FLEX 8000 devices is three bits. [Table 7](#) shows the boundary-scan register length for FLEX 8000 devices.

Table 7. FLEX 8000 Boundary-Scan Register Length

Device	Boundary-Scan Register Length
EPF8282A, EPF8282AV	273
EPF8636A	417
EPF8820A	465
EPF81500A	645

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. [Figure 14](#) shows the timing requirements for the JTAG signals.

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms



[Table 8](#) shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

Table 10. FLEX 8000 5.0-V Device Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CCINT}	Supply voltage for internal logic and input buffers	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
V_{CCIO}	Supply voltage for output buffers, 5.0-V operation	(3), (4)	4.75 (4.50)	5.25 (5.50)	V
	Supply voltage for output buffers, 3.3-V operation	(3), (4)	3.00 (3.00)	3.60 (3.60)	V
V_I	Input voltage		-0.5	$V_{CCINT} + 0.5$	V
V_O	Output voltage		0	V_{CCIO}	V
T_A	Operating temperature	For commercial use	0	70	°C
		For industrial use	-40	85	°C
t_R	Input rise time			40	ns
t_F	Input fall time			40	ns

Table 11. FLEX 8000 5.0-V Device DC Operating Conditions *Notes (5), (6)*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IH}	High-level input voltage		2.0		$V_{CCINT} + 0.5$	V
V_{IL}	Low-level input voltage		-0.5		0.8	V
V_{OH}	5.0-V high-level TTL output voltage	$I_{OH} = -4 \text{ mA DC}$ (7) $V_{CCIO} = 4.75 \text{ V}$	2.4			V
	3.3-V high-level TTL output voltage	$I_{OH} = -4 \text{ mA DC}$ (7) $V_{CCIO} = 3.00 \text{ V}$	2.4			V
	3.3-V high-level CMOS output voltage	$I_{OH} = -0.1 \text{ mA DC}$ (7) $V_{CCIO} = 3.00 \text{ V}$	$V_{CCIO} - 0.2$			V
V_{OL}	5.0-V low-level TTL output voltage	$I_{OL} = 12 \text{ mA DC}$ (7) $V_{CCIO} = 4.75 \text{ V}$			0.45	V
	3.3-V low-level TTL output voltage	$I_{OL} = 12 \text{ mA DC}$ (7) $V_{CCIO} = 3.00 \text{ V}$			0.45	V
	3.3-V low-level CMOS output voltage	$I_{OL} = 0.1 \text{ mA DC}$ (7) $V_{CCIO} = 3.00 \text{ V}$			0.2	V
I_I	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	µA
I_{OZ}	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	µA
I_{CC0}	V_{CC} supply current (standby)	$V_I = \text{ground, no load}$		0.5	10	mA

Table 12. FLEX 8000 5.0-V Device Capacitance Note (8)

Symbol	Parameter	Conditions	Min	Max	Unit
C _{IN}	Input capacitance	V _{IN} = 0 V, f = 1.0 MHz		10	pF
C _{OUT}	Output capacitance	V _{OUT} = 0 V, f = 1.0 MHz		10	pF

Notes to tables:

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input is -0.5 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) The maximum V_{CC} rise time is 100 ms.
- (4) Numbers in parentheses are for industrial-temperature-range devices.
- (5) Typical values are for T_A = 25° C and V_{CC} = 5.0 V.
- (6) These values are specified in Table 10 on page 28.
- (7) The I_{OH} parameter refers to high-level TTL or CMOS output current; the I_{OL} parameter refers to low-level TTL or CMOS output current.
- (8) Capacitance is sample-tested only.

Tables 13 through 16 provide information on absolute maximum ratings, recommended operating conditions, operating conditions, and capacitance for 3.3-V FLEX 8000 devices.

Table 13. FLEX 8000 3.3-V Device Absolute Maximum Ratings Note (1)

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply voltage	With respect to ground (2)	-2.0	5.3	V
V _I	DC input voltage		-2.0	5.3	V
I _{OUT}	DC output current, per pin		-25	25	mA
T _{STG}	Storage temperature	No bias	-65	150	° C
T _{AMB}	Ambient temperature	Under bias	-65	135	° C
T _J	Junction temperature	Plastic packages, under bias		135	° C

Table 14. FLEX 8000 3.3-V Device Recommended Operating Conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	Supply voltage	(3)	3.0	3.6	V
V _I	Input voltage		-0.3	V _{CC} + 0.3	V
V _O	Output voltage		0	V _{CC}	V
T _A	Operating temperature	For commercial use	0	70	° C
t _R	Input rise time			40	ns
t _F	Input fall time			40	ns

Table 15. FLEX 8000 3.3-V Device DC Operating Conditions Note (4)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IH}	High-level input voltage		2.0		$V_{CC} + 0.3$	V
V_{IL}	Low-level input voltage		-0.3		0.8	V
V_{OH}	High-level output voltage	$I_{OH} = -0.1 \text{ mA DC}$ (5)	$V_{CC} - 0.2$			V
V_{OL}	Low-level output voltage	$I_{OL} = 4 \text{ mA DC}$ (5)			0.45	V
I_I	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	μA
I_{OZ}	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	μA
I_{CC0}	V_{CC} supply current (standby)	$V_I = \text{ground, no load}$ (6)		0.3	10	mA

Table 16. FLEX 8000 3.3-V Device Capacitance Note (7)

Symbol	Parameter	Conditions	Min	Max	Unit
C_{IN}	Input capacitance	$V_{IN} = 0 \text{ V}, f = 1.0 \text{ MHz}$		10	pF
C_{OUT}	Output capacitance	$V_{OUT} = 0 \text{ V}, f = 1.0 \text{ MHz}$		10	pF

Notes to tables:

- (1) See the [Operating Requirements for Altera Devices Data Sheet](#).
- (2) Minimum DC input voltage is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.3 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) The maximum V_{CC} rise time is 100 ms. V_{CC} must rise monotonically.
- (4) These values are specified in [Table 14 on page 29](#).
- (5) The I_{OH} parameter refers to high-level TTL output current; the I_{OL} parameter refers to low-level TTL output current.
- (6) Typical values are for $T_A = 25^\circ \text{C}$ and $V_{CC} = 3.3 \text{ V}$.
- (7) Capacitance is sample-tested only.

Figure 16 shows the typical output drive characteristics of 5.0-V FLEX 8000 devices. The output driver is compliant with *PCI Local Bus Specification, Revision 2.2*.

Table 23. EPF8282A Interconnect Timing Parameters

Symbol	Speed Grade						Unit	
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
$t_{LABCASC}$		0.3		0.3		0.4	ns	
$t_{LABCARRY}$		0.3		0.3		0.4	ns	
t_{LOCAL}		0.5		0.6		0.8	ns	
t_{ROW}		4.2		4.2		4.2	ns	
t_{COL}		2.5		2.5		2.5	ns	
t_{DIN_C}		5.0		5.0		5.5	ns	
t_{DIN_D}		7.2		7.2		7.2	ns	
t_{DIN_IO}		5.0		5.0		5.5	ns	

Table 26. EPF8282AV I/O Element Timing Parameters

Symbol	Speed Grade				Unit	
	A-3		A-4			
	Min	Max	Min	Max		
t_{IOD}		0.9		2.2	ns	
t_{IOC}		1.9		2.0	ns	
t_{IOE}		1.9		2.0	ns	
t_{OCO}		1.0		2.0	ns	
$t_{IOPCOMB}$		0.1		0.0	ns	
t_{IOSU}	1.8		2.8		ns	
t_{IOH}	0.0		0.2		ns	
t_{IOCLR}		1.2		2.3	ns	
t_{IN}		1.7		3.4	ns	
t_{OD1}		1.7		4.1	ns	
t_{OD2}		—		—	ns	
t_{OD3}		5.2		7.1	ns	
t_{XZ}		1.8		4.3	ns	
t_{ZX1}		1.8		4.3	ns	
t_{ZX2}		—		—	ns	
t_{ZX3}		5.3		8.3	ns	

Table 27. EPF8282AV Interconnect Timing Parameters

Symbol	Speed Grade				Unit	
	A-3		A-4			
	Min	Max	Min	Max		
$t_{LABCASC}$		0.4		1.3	ns	
$t_{LABCARRY}$		0.4		0.8	ns	
t_{LOCAL}		0.8		1.5	ns	
t_{ROW}		4.2		6.3	ns	
t_{COL}		2.5		3.8	ns	
t_{DIN_C}		5.5		8.0	ns	
t_{DIN_D}		7.2		10.8	ns	
t_{DIN_IO}		5.5		9.0	ns	

Table 30. EPF8452A I/O Element Timing Parameters

Symbol	Speed Grade						Unit	
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
t_{IOD}		0.7		0.8		0.9	ns	
t_{IOC}		1.7		1.8		1.9	ns	
t_{IOE}		1.7		1.8		1.9	ns	
t_{IOCO}		1.0		1.0		1.0	ns	
t_{IOCOMB}		0.3		0.2		0.1	ns	
t_{IOSU}	1.4		1.6		1.8		ns	
t_{IOH}	0.0		0.0		0.0		ns	
t_{IOCLR}		1.2		1.2		1.2	ns	
t_{IN}		1.5		1.6		1.7	ns	
t_{OD1}		1.1		1.4		1.7	ns	
t_{OD2}		—		—		—	ns	
t_{OD3}		4.6		4.9		5.2	ns	
t_{XZ}		1.4		1.6		1.8	ns	
t_{ZX1}		1.4		1.6		1.8	ns	
t_{ZX2}		—		—		—	ns	
t_{ZX3}		4.9		5.1		5.3	ns	

Table 31. EPF8452A Interconnect Timing Parameters

Symbol	Speed Grade						Unit	
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
$t_{LABCASC}$		0.3		0.4		0.4	ns	
$t_{LABCARRY}$		0.3		0.4		0.4	ns	
t_{LOCAL}		0.5		0.5		0.7	ns	
t_{ROW}		5.0		5.0		5.0	ns	
t_{COL}		3.0		3.0		3.0	ns	
t_{DIN_C}		5.0		5.0		5.5	ns	
t_{DIN_D}		7.0		7.0		7.5	ns	
t_{DIN_IO}		5.0		5.0		5.5	ns	

Table 32. EPF8452A LE Timing Parameters

Symbol	Speed Grade						Unit	
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
t_{LUT}		2.0		2.3		3.0	ns	
t_{CLUT}		0.0		0.2		0.1	ns	
t_{RLUT}		0.9		1.6		1.6	ns	
t_{GATE}		0.0		0.0		0.0	ns	
t_{CASC}		0.6		0.7		0.9	ns	
t_{CICO}		0.4		0.5		0.6	ns	
t_{CGEN}		0.4		0.9		0.8	ns	
t_{CGENR}		0.9		1.4		1.5	ns	
t_c		1.6		1.8		2.4	ns	
t_{CH}	4.0		4.0		4.0		ns	
t_{CL}	4.0		4.0		4.0		ns	
t_{CO}		0.4		0.5		0.6	ns	
t_{COMB}		0.4		0.5		0.6	ns	
t_{SU}	0.8		1.0		1.1		ns	
t_H	0.9		1.1		1.4		ns	
t_{PRE}		0.6		0.7		0.8	ns	
t_{CLR}		0.6		0.7		0.8	ns	

Table 33. EPF8452A External Timing Parameters

Symbol	Speed Grade						Unit	
	A-2		A-3		A-4			
	Min	Max	Min	Max	Min	Max		
t_{DRR}		16.0		20.0		25.0	ns	
t_{ODH}	1.0		1.0		1.0		ns	

Power Consumption

The supply power (P) for FLEX 8000 devices can be calculated with the following equation:

$$P = P_{\text{INT}} + P_{\text{IO}} = [(I_{\text{CCSTANDBY}} + I_{\text{CCACTIVE}}) \times V_{\text{CC}}] + P_{\text{IO}}$$

Typical $I_{\text{CCSTANDBY}}$ values are shown as $I_{\text{CC}0}$ in Table 11 on page 28 and Table 15 on page 30. The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in [Application Note 74 \(Evaluating Power for Altera Devices\)](#). The I_{CCACTIVE} value depends on the switching frequency and the application logic. This value can be calculated based on the amount of current that each LE typically consumes.

The following equation shows the general formula for calculating I_{CCACTIVE} :

$$I_{\text{CCACTIVE}} = K \times f_{\text{MAX}} \times N \times \text{tog}_{\text{LC}} \times \frac{\mu\text{A}}{\text{MHz} \times \text{LE}}$$

The parameters in this equation are shown below:

- f_{MAX} = Maximum operating frequency in MHz
- N = Total number of logic cells used in the device
- tog_{LC} = Average percentage of logic cells toggling at each clock
- K = Constant, shown in [Table 50](#)

Table 50. Values for Constant K

Device	K
5.0-V FLEX 8000 devices	75
3.3-V FLEX 8000 devices	60

This calculation provides an I_{CC} estimate based on typical conditions with no output load. The actual I_{CC} value should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

[Figure 20](#) shows the relationship between I_{CC} and operating frequency for several LE utilization values.

Device Pin-Outs

Tables 52 through 54 show the pin names and numbers for the dedicated pins in each FLEX 8000 device package.

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
nSP (2)	75	75	75	76	110	R1	1
MSEL0 (2)	74	74	74	75	109	P2	2
MSEL1 (2)	53	53	51	51	72	A1	44
nSTATUS (2)	32	32	24	25	37	C13	82
nCONFIG (2)	33	33	25	26	38	A15	81
DCLK (2)	10	10	100	100	143	P14	125
CONF_DONE (2)	11	11	1	1	144	N13	124
nWS	30	30	22	23	33	F13	87
nRS	48	48	42	45	31	C6	89
RDCLK	49	49	45	46	12	B5	110
nCS	29	29	21	22	4	D15	118
CS	28	28	19	21	3	E15	121
RDYnBUSY	77	77	77	78	20	P3	100
CLKUSR	50	50	47	47	13	C5	107
ADD17	51	51	49	48	75	B4	40
ADD16	36	55	28	54	76	E2	39
ADD15	56	56	55	55	77	D1	38
ADD14	57	57	57	57	78	E1	37
ADD13	58	58	58	58	79	F3	36
ADD12	60	60	59	60	83	F2	32
ADD11	61	61	60	61	85	F1	30
ADD10	62	62	61	62	87	G2	28
ADD9	63	63	62	64	89	G1	26
ADD8	64	64	64	65	92	H1	22
ADD7	65	65	65	66	94	H2	20
ADD6	66	66	66	67	95	J1	18
ADD5	67	67	67	68	97	J2	16
ADD4	69	69	68	70	102	K2	11
ADD3	70	70	69	71	103	K1	10
ADD2	71	71	71	72	104	K3	8
ADD1	76	72	76	73	105	M1	7

Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A (1)
nSP (2)	120	1	R15	207	207	5
MSEL0 (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	T3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	T8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 3 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
GND	B1, D4, E14, F7, F8, F9, F12, G6, G7, G8, G9, G10, H1, H4, H5, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K6, K7, K8, K9, K11, L15, N3, P1	A1, D6, E11, E7, E9, G4, G5, G13, G14, J5, J13, K4, K14, L5, L13, N4, N7, N9, N11, N14	8, 9, 30, 31, 52, 53, 72, 90, 108, 115, 129, 139, 151, 161, 173, 185, 187, 193, 211, 229	6, 7, 28, 29, 50, 51, 71, 85, 92, 101, 118, 119, 140, 141, 162, 163, 184, 185, 186, 198, 208, 214, 228	D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17	9, 11, 36, 38, 65, 67, 90, 108, 116, 128, 150, 151, 175, 177, 206, 208, 231, 232, 237, 253, 265, 273, 291
No Connect (N.C.)	—	—	61, 62, 119, 120, 181, 182, 239, 240	—	—	10, 21, 23, 25, 35, 37, 39, 40, 41, 42, 52, 55, 66, 68, 146, 147, 161, 173, 174, 176, 187, 188, 189, 190, 192, 194, 195, 205, 207, 219, 221, 233, 234, 235, 236, 302, 303
Total User I/O Pins (9)	148	180	180	177	204	204

Notes to tables:

- (1) Perform a complete thermal analysis before committing a design to this device package. See [Application Note 74 \(Evaluating Power for Altera Devices\)](#) for more information.
- (2) This pin is a dedicated pin and is not available as a user I/O pin.
- (3) SDOUT will drive out during configuration. After configuration, it may be used as a user I/O pin. By default, the MAX+PLUS II software will not use SDOUT as a user I/O pin; the user can override the MAX+PLUS II software and use SDOUT as a user I/O pin.
- (4) If the device is not configured to use the JTAG BST circuitry, this pin is available as a user I/O pin.
- (5) JTAG pins are available for EPF8636A devices only. These pins are dedicated user I/O pins.
- (6) If this pin is used as an input in user mode, ensure that it does not toggle before or during configuration.
- (7) TRST is a dedicated input pin for JTAG use. This pin must be grounded if JTAG BST is not used.
- (8) Pin 52 is a V_{CC} pin on EPF8452A devices only.
- (9) The user I/O pin count includes dedicated input pins and all I/O pins.
- (10) Unused dedicated inputs should be tied to ground on the board.
- (11) SDOUT does not exist in the EPF8636GC192 device.
- (12) These pins are no connect (N.C.) pins for EPF8636A devices only. They are user I/O pins in EPF8820A devices.
- (13) EPF8636A devices have 132 user I/O pins; EPF8820A devices have 148 user I/O pins.
- (14) For EPF81500A devices, these pins are dedicated JTAG pins and are not available as user I/O pins. If JTAG BST is not used, TDI, TCK, TMS, and TRST should be tied to GND.

Revision History

The information contained in the *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 supersedes information published in previous versions. The *FLEX 8000 Programmable Logic Device Family Data Sheet* version 11.1 contains the following change: minor textual updates.